

MCR68–2



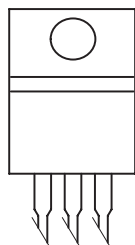
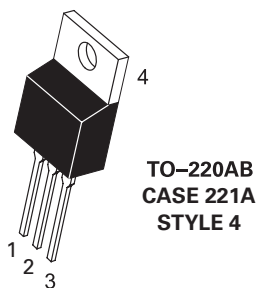
Description

Designed for overvoltage protection in crowbar circuits.

Features

- Glass-Passivated Junctions for Greater Parameter Stability and Reliability
- Center-Gate Geometry for Uniform Current Spreading Enabling High Discharge Current
- Small Rugged, Thermowatt Package Constructed for Low Thermal Resistance and Maximum Power Dissipation and Durability
- High Capacitor Discharge Current, 300 Amps
- Pb-Free Package is Available

Pin Out



Functional Diagram



Additional Information



Datasheet



Resources



Samples

Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (– 40 to 125°C , Sine Wave, 50 to 60 Hz, Gate Open) MCR68-2	V_{DRM} V_{RRM}	50	V
On-State RMS Current (180° Conduction Angles; $T_C = 85^\circ\text{C}$)	$I_{\text{TM (RMS)}}$	12	A
Peak Discharge Current (Note 2)	I_{TM}	300	A
Average On-State Current (180° Conduction Angles; $T_C = 85^\circ\text{C}$)	$I_{\text{T(AV)}}$	8.0	A
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 125^\circ\text{C}$)	I_{TSM}	100	A
Circuit Fusing Consideration ($t = 8.3$ ms)	I^2t	40	A^2sec
Forward Peak Gate Current (Pulse Width ≤ 1.0 μsec , $T_C = 80^\circ\text{C}$)	I_{GM}	2.0	A
Forward Peak Gate Current (Pulse Width ≤ 1.0 μsec , $T_C = 85^\circ\text{C}$)	I_{GM}	20	W
Forward Average Gate Power ($t = 8.3$ ms, $T_C = 85^\circ\text{C}$)	$P_{\text{G(AV)}}$	0.5	W
Operating Junction Temperature Range	T_J	–40 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	–40 to +150	$^\circ\text{C}$
Mounting Torque	–	8.0	in. lb.

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- Ratings apply for $t_w = 1$ ms. See Figure 1 for I_{TM} capability for various duration of an exponentially decaying current waveform, t_w is defined as 5 time constants of an exponentially decaying current pulse.

Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance, Junction–to–Case	R_{JC}	2.0	$^\circ\text{C/W}$
Thermal Resistance, Junction–to–Ambient	R_{JA}	60	
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T_L	260	$^\circ\text{C}$

Electrical Characteristics - OFF ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current ($V_{AK} = \text{Rated } V_{DRM}$ or V_{RRM} , Gate Open)	$T_J = 25^\circ\text{C}$	I_{DRM}	-	-	10	μA
	$T_J = 125^\circ\text{C}$	I_{RRM}	-	-	2.0	mA

Electrical Characteristics - ON ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
Peak Forward On-State Voltage (Note 2) ($I_{TM} = 32\text{ A}$) ($I_{TM} = 24\text{ A}$) (Note 3) ($I_{TM} = 300\text{ A}$, $tw = 1\text{ ms}$) (Note 4)		V_{TM}	-	-	2.2	V
			-	6.0	-	
Gate Trigger Current (Continuous dc) ($V_D = 12\text{ V}$; $R_L = 100\ \Omega$)		I_{GT}	2.0	7.0	30	mA
Gate Trigger Voltage (Continuous dc) ($V_D = 12\text{ V}$; $R_L = 100\ \Omega$)		V_{GT}	-	0.65	1.5	V
Gate Trigger Non-Current (Continuous dc) ($V_D = 12\text{ V}$; $R_L = 100\ \Omega$)		V_{GD}	0.2	0.40	-	V
Holding Current ($V_D = 12\text{ V}$, Initiating Current = 200 mA, Gate Open)		I_H	3.0	15	50	mA
Latch Current ($V_D = 12\text{ V}$, $I_G = 30\text{ mA}$)		I_L	-	35	80	mA
Gate Controlled Turn-On Time (Note 5) ($V_D = \text{Rated } V_{DRM}$, $I_G = 150\text{ mA}$) ($I_{TM} = 24\text{ A Peak}$)		V_{GT}	-	1.0	-	μs

Dynamic Characteristics

Characteristic	Symbol	Min	Typ	Max	Unit
Critical Rate of Rise of Off-State Voltage ($V_D = \text{Rated } V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 125^\circ\text{C}$)	dv/dt	10	-	-	V/ μs
Critical Rate of Rise of On-State Current $I_G = 150\text{ A}$ $T_J = 125^\circ\text{C}$	di/dt	-	-	75	A/ μs

3. Pulse duration $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

4. Ratings apply for $tw = 1\text{ ms}$. See Figure 1 for I_{TM} capability for various durations of an exponentially decaying current waveform. tw is defined as 5 time constants of an exponentially decaying current pulse.

5. The gate controlled turn-on time in a crowbar circuit will be influenced by the circuit inductance.

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I_H	Holding Current

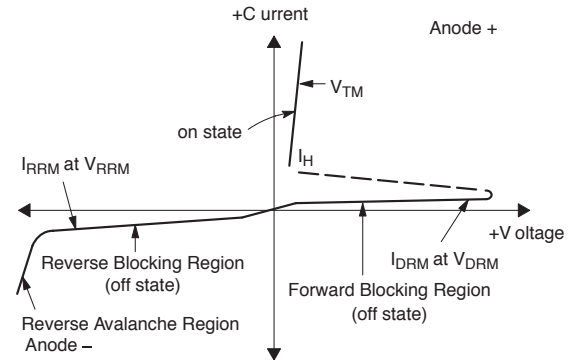


Figure 1. Peak Capacitor Discharge Current

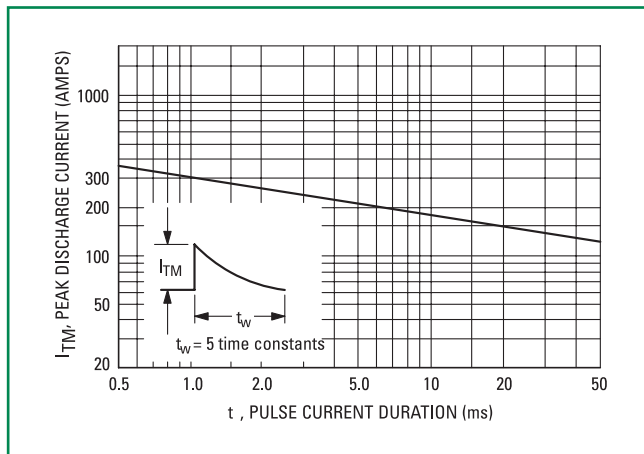


Figure 2. Peak Capacitor Discharge Current Derating

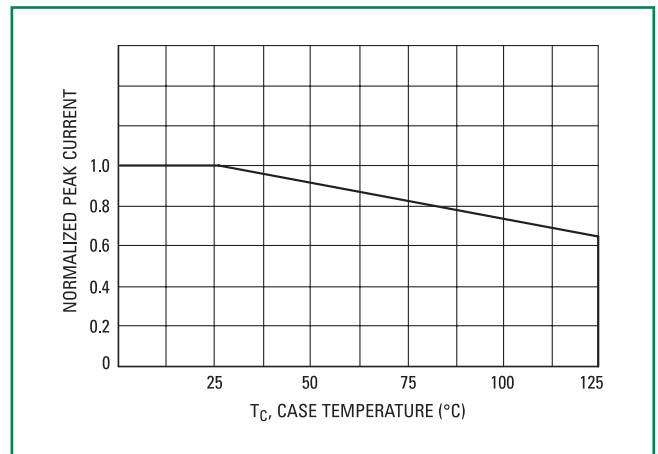


Figure 3. Current Derating

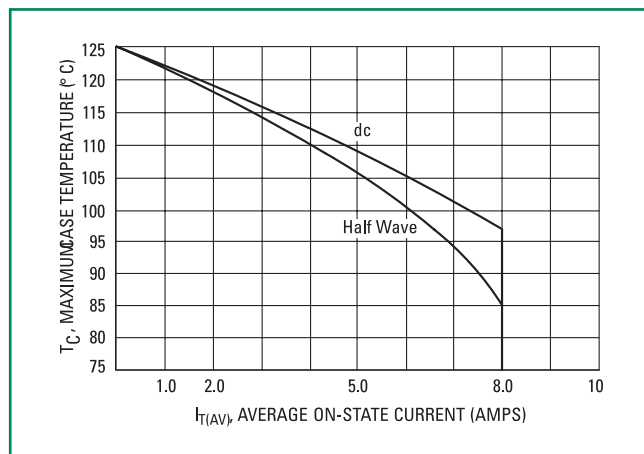


Figure 4. Maximum Power Dissipation

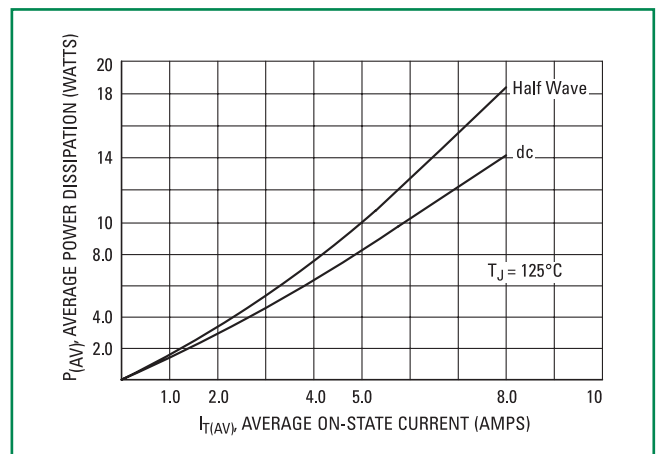


Figure 5. Thermal Response

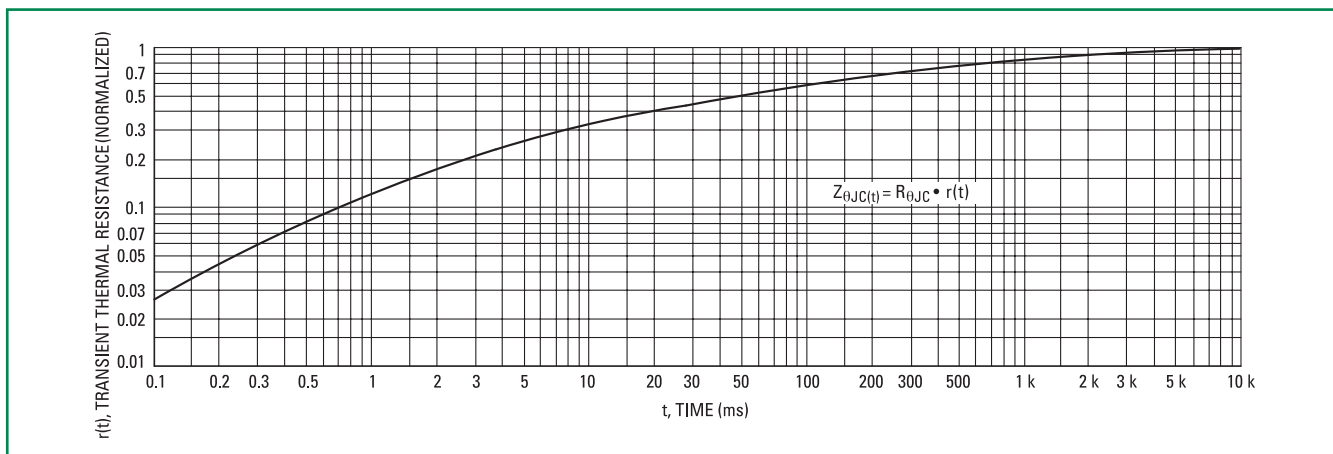


Figure 6. Gate Trigger Current

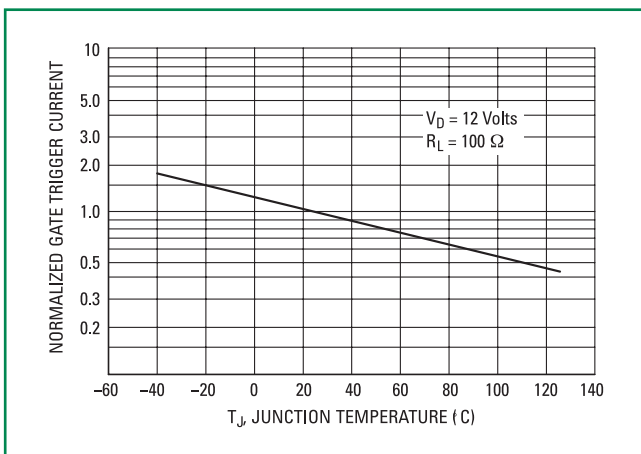


Figure 7. Gate Trigger Voltage

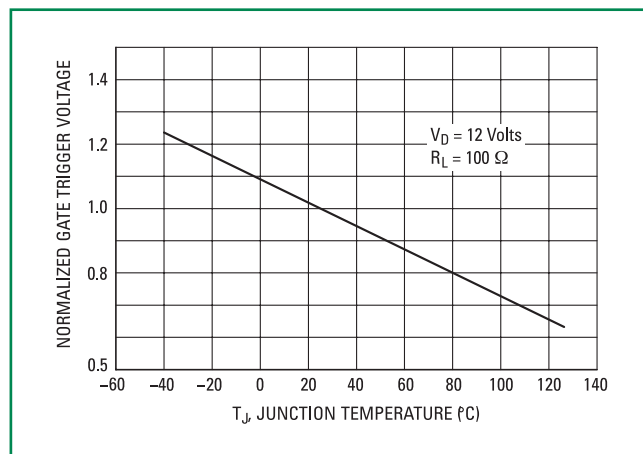
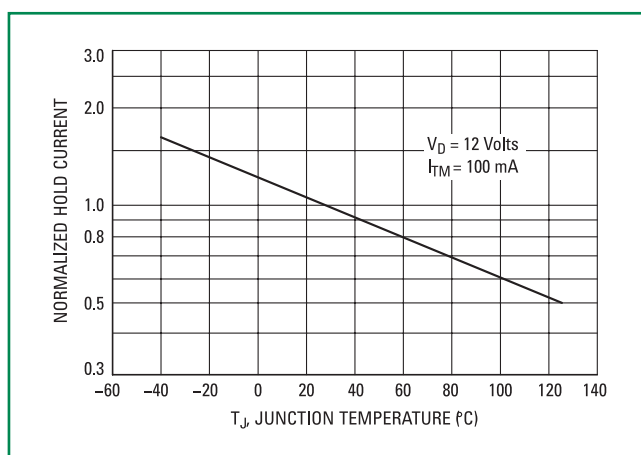
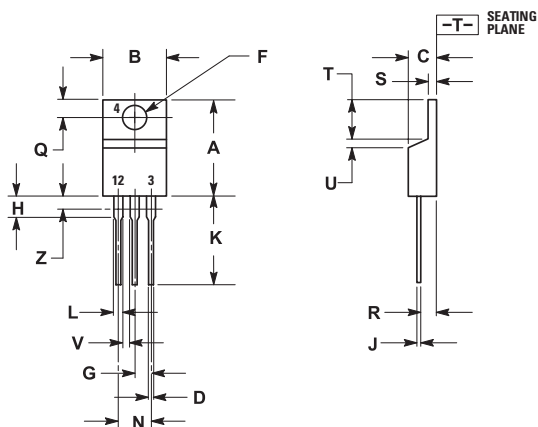


Figure 8. Holding Current



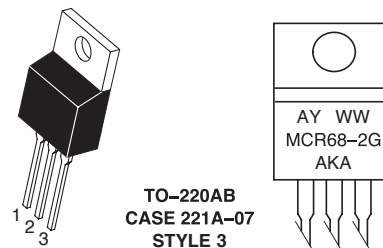
Dimensions



Dim	Inches		Millimeters	
	Min	Max	Min	Max
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

Part Marking System



A= Assembly Location
Y= Year
WW = Work Week
G = Pb-Free Package
AKA= Diode Polarity

Pin Assignment

1	Cathode
2	Anode
3	Gate
4	Anode

Ordering Information

Device	Package	Shipping
MCR68-2	TO-220AB (Pb-Free)	50 0Units / Box
MCR68-2G		

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